## Office of the Director

## Directorate of Technical Education, Vocational and Industrial Training Sunder Nagar, Mandi, Himachal Pradesh

**Invitation for Bids No.: 004/2019** Date: 01/06/2019

Loan/Grant No. and Title: Loan No.: 3573-IND/ Himachal Pradesh Skill Development Project.

Contract Package No. and Title: **HPSDP-DOTE/02**; Supply of **Information Technology and related equipment's** for Industrial Training Institutes to enhance Technical and Vocational Skills among the youth of Himachal Pradesh (**Package-02**), comprising of following lots:

Lot-1: Computers

**Lot-2**: Peripheral Devices

Lot-3: IT tools and components

Lot-4: Softwares

Deadline for Submission of Bids 1st July 2019 at 13:30 hrs. (IST)

- 1. India has applied for financing from the Asian Development Bank (ADB) toward the cost of "Himachal Pradesh Skill Development Project" and it intends to apply part of the proceeds of this financing to the payment under the Contract Package named above. Bidding is open to Bidders from eligible source countries of ADB.
- 2. The "Directorate of Technical Education, Vocational and Industrial Training, Himachal Pradesh", represented by the Director ("The Purchaser") invites sealed bids from eligible Bidders for the Supply of **Information Technology and related equipment's** for Industrial Training Institutes.

Lot-1: Computers

Lot-2: Peripheral Devices

**Lot-3**: IT tools and components

**Lot-4**: Softwares

- 3. **National Competitive Bidding** will be conducted in accordance with ADB's Single-stage: Two-envelope bidding procedure and is open to all Bidders from eligible countries as described in the Bidding Document.
- 4. Only eligible Bidders with the following key qualifications should participate in this bidding:
- a) Successful completion as main supplier within the last three (3) years, of at least One (1) contract with nature, and complexity similar to the scope of supply described in Section 6 (Schedule of Supply). The contract value Lot-wise is indicated below:

**INR 317.76 Lakhs** for Lot-1 (Computers)

**INR 38.90 Lakhs** for Lot-2 (Peripheral Devices)

**INR 57.52 Lakhs** for Lot-3 (IT tools and components)

**INR 50.12 Lakhs** for Lot-4 (Softwares)

Bidder bidding for more than 1 (one) Package has to submit the Work Experience accordingly.

b) Minimum average annual turnover as indicated below calculated as total payments received by the Bidder for contracts completed or under execution over the last three (3) years.

The Average Annual Turnover Lot-wise is indicated below:

**INR 794.4 Lakhs** for Lot-1 (Computers)

**INR 97.26 Lakhs** for Lot-2 (Peripheral Devices)

**INR 143.81 Lakhs** for Lot-3 (IT tools and components)

**INR 125.3 Lakhs** for Lot-4 (Softwares)

- c) However, for complete eligibility and qualification requirements, bid document should be referred.
- 5. To obtain further information and inspect the bidding documents, Bidders should contact:

Attention: The Director,

Directorate of Technical Education, Vocational

and Industrial Training

Circular Road, Lalit Chowk, Sunder Nagar,

District: Mandi, Himachal Pradesh - ZIP code: 175018

Country: India

Telephone & Fax: 01907-266120; 266722

E-mail address: techedu-hp@nic.in

6. To purchase the bidding documents in English language, eligible Bidders should write or visit at the office of the Purchaser at address stated above and pay a non-refundable fee of INR 10,000 in the form of Bank Demand Draft. In case of written request, the document will be sent by post and no liability will be accepted, for loss or late delivery. The eligible bidders may otherwise download the bidding document for English language from the website

http://himachal.nic.in/index1.php?lang=1&dpt id=2&level=1&lid=1151&sublinkid=1900, such bidders shall be required to submit INR 10,000 with their bid in the form of Bank demand draft in the name of the Director Technical Education, Sundernagar, HP towards cost of bidding document.

- 7. Deliver your bid
  - to the address above
  - On or before the deadline: 1<sup>st</sup> July 2019 at 13:30 hrs. (IST)
  - together with a Bid Security as described in the Bidding Document.
- 8. Bids will be opened on 1<sup>st</sup> July 2019 at 14:30 hrs. (IST) in the presence of Bidders' representatives who choose to attend.
- 9. The Purchaser will not be responsible for any cost or expenses incurred by the bidder in connection with the preparation or delivery of bids.

-sd-Director